

# SD211DE/SST211 Series

## N-Channel Lateral DMOS FETs

**SD211DE**  
**SD213DE**  
**SD215DE**

**SST211**  
**SST213**  
**SST215**

### Product Summary

Part Number	$V_{(BR)DS}$ Min (V)	$V_{GS(th)}$ Max (V)	$r_{DS(on)}$ Max ( $\Omega$ )	$C_{rss}$ Max (pF)	$t_{ON}$ Max (ns)
SD211DE	30	1.5	45 @ $V_{GS} = 10$ V	0.5	2
SD213DE	10	1.5	45 @ $V_{GS} = 10$ V	0.5	2
SD215DE	20	1.5	45 @ $V_{GS} = 10$ V	0.5	2
SST211	30	1.5	50 @ $V_{GS} = 10$ V	0.5	2
SST213	10	1.5	50 @ $V_{GS} = 10$ V	0.5	2
SST215	20	1.5	50 @ $V_{GS} = 10$ V	0.5	2

### Features

- Ultra-High Speed Switching— $t_{ON}$ : 1 ns
- Ultra-Low Reverse Capacitance: 0.2 pF
- Low Guaranteed  $r_{DS}$  @ 5 V
- Low Turn-On Threshold Voltage
- N-Channel Enhancement Mode

### Benefits

- High Speed System Performance
- Low Insertion Loss at High Frequencies
- Low Transfer Signal Loss
- Simple Driver Requirement
- Single Supply Operation

### Applications

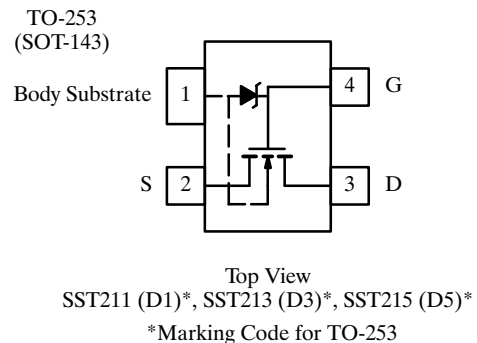
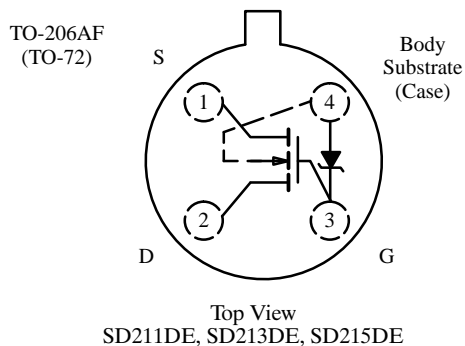
- Fast Analog Switch
- Fast Sample-and-Holds
- Pixel-Rate Switching
- DAC Deglitchers
- High-Speed Driver

### Description

The SD211DE/SST211 series consists of enhancement-mode MOSFETs designed for high speed low-glitch switching in audio, video, and high-frequency applications. The SD211 may be used for  $\pm 5$ -V analog switching or as a high speed driver of the SD214. The SD214 is normally used for  $\pm 10$ -V analog switching. These MOSFETs utilize lateral construction to achieve low capacitance and ultra-fast switching speeds. An

integrated Zener diode provides ESD protection. These devices feature a poly-silicon gate for manufacturing reliability.

For similar products see: quad array—SD5000/5400 series and non-Zener protection—SD210DE/214DE.



Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70295. Applications information may also be obtained via FaxBack, request document #70607.

# SD211DE/SST211 Series

## Absolute Maximum Ratings (T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Gate-Drain, Gate-Source Voltage (SD211DE/SST211) . . . . .	-30/25 V	Source-Substrate Voltage (SD211DE/SST211) . . . . .	15 V
(SD213DE/SST213) . . . . .	-15/25 V	(SD213DE/SST213) . . . . .	15 V
(SD215DE/SST215) . . . . .	-25/30 V	(SD215DE/SST215) . . . . .	25 V
Gate-Substrate Voltage <sup>a</sup> (SD211DE/SST211) . . . . .	-0.3/25 V	Drain Current . . . . .	50 mA
(SD213DE/SST213) . . . . .	-0.3/25 V	Lead Temperature ( <sup>1</sup> / <sub>16</sub> " from case for 10 seconds) . . . . .	300 °C
(SD215DE/SST215) . . . . .	-0.3/30 V	Storage Temperature . . . . .	-65 to 150 °C
Drain-Source Voltage (SD211DE/SST211) . . . . .	30 V	Operating Junction Temperature . . . . .	-55 to 125 °C
(SD213DE/SST213) . . . . .	10 V	Power Dissipation <sup>a</sup> . . . . .	300 mW
(SD215DE/SST215) . . . . .	20 V		
Source-Drain Voltage (SD211DE/SST211) . . . . .	10 V		
(SD213DE/SST213) . . . . .	10 V		
(SD215DE/SST215) . . . . .	20 V		
Drain-Substrate Voltage (SD211DE/SST211) . . . . .	30 V		
(SD213DE/SST213) . . . . .	15 V		
(SD215DE/SST215) . . . . .	25 V		

Notes:  
a. Derate 3 mW/°C above 25 °C

## Specifications<sup>a</sup>

Parameter	Symbol <sup>b</sup>	Test Conditions <sup>b</sup>	Typ <sup>c</sup>	Limits						Unit	
				211 Series		213 Series		215 Series			
				Min	Max	Min	Max	Min	Max		
<b>Static</b>											
Drain-Source Breakdown Voltage	V <sub>(BR)DS</sub>	V <sub>GS</sub> = V <sub>BS</sub> = 0 V, I <sub>D</sub> = 10 μA	35	30						V	
		V <sub>GS</sub> = V <sub>BS</sub> = -5 V, I <sub>D</sub> = 10 nA	30	10		10		20			
Source-Drain Breakdown Voltage	V <sub>(BR)SD</sub>	V <sub>GD</sub> = V <sub>BD</sub> = -5 V, I <sub>S</sub> = 10 nA	22	10		10		20		V	
Drain-Substrate Breakdown Voltage	V <sub>(BR)DBO</sub>	V <sub>GB</sub> = 0 V, I <sub>D</sub> = 10 nA, Source Open	35	15		15		25		V	
Source-Substrate Breakdown Voltage	V <sub>(BR)SBO</sub>	V <sub>GB</sub> = 0 V, I <sub>S</sub> = 10 μA, Drain Open	35	15		15		25		V	
Drain-Source Leakage	I <sub>DS(off)</sub>	V <sub>GS</sub> = V <sub>BS</sub> = -5 V	V <sub>DS</sub> = 10 V	0.4		10		10		nA	
			V <sub>DS</sub> = 20 V	0.9					10		
Source-Drain Leakage	I <sub>SD(off)</sub>	V <sub>GD</sub> = V <sub>BD</sub> = -5 V	V <sub>SD</sub> = 10 V	0.5		10		10		nA	
			V <sub>SD</sub> = 20 V	1					10		
Gate Leakage	I <sub>GBS</sub>	V <sub>DB</sub> = V <sub>SB</sub> = 0 V, V <sub>GB</sub> = 30V	0.01		100		100		100	nA	
Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1 μA V <sub>SB</sub> = 0 V	0.8	0.5	1.5	0.1	1.5	0.1	1.5	V	
Drain-Source On-Resistance	r <sub>DS(on)</sub>	V <sub>SB</sub> = 0 V I <sub>D</sub> = 1 mA	V <sub>GS</sub> = 5 V (SD Series)	58		70		70		70	Ω
			V <sub>GS</sub> = 5 V (SST Series)	60		75		75		75	
			V <sub>GS</sub> = 10 V (SD Series)	38		45		45		45	
			V <sub>GS</sub> = 10 V (SST Series)	40		50		50		50	
			V <sub>GS</sub> = 15 V	30							
			V <sub>GS</sub> = 20 V	26							
			V <sub>GS</sub> = 25 V	24							

# SD211DE/SST211 Series

## Specifications<sup>a</sup>

Parameter	Symbol <sup>b</sup>	Test Conditions <sup>b</sup>	Typ <sup>c</sup>	Limits						Unit	
				211 Series		213 Series		215 Series			
				Min	Max	Min	Max	Min	Max		
<b>Dynamic</b>											
Forward Transconductance	$g_{fs}$	$V_{DS} = 10\text{ V}$ $V_{SB} = 0\text{ V}$ $I_D = 20\text{ mA}, f = 1\text{ kHz}$	SD Series	11	10		10		10		mS
			SST Series	10.5	9		9		9		
	$g_{os}$		All	0.9							
Gate Node Capacitance	$C_{(GS+GD+GB)}$	$V_{DS} = 10\text{ V}$ $f = 1\text{ MHz}$ $V_{GS} = V_{BS} = -15\text{ V}$	SD Series	2.5		3.5		3.5		3.5	pF
Drain Node Capacitance	$C_{(GD+DB)}$			1.1		1.5		1.5		1.5	
Source Node Capacitance	$C_{(GS+SB)}$			3.7		5.5		5.5		5.5	
Reverse Transfer Capacitance	$C_{rss}$			SST Series	4.2						
			SD Series	0.2		0.5		0.5		0.5	
<b>Switching</b>											
Turn-On Time	$t_{d(on)}$	SD Series Only $V_{SB} = 0\text{ V}, V_{IN} 0\text{ to }5\text{ V}, R_G = 25\ \Omega$ $V_{DD} = 5\text{ V}, R_L = 680\ \Omega$		0.5		1		1		1	ns
	$t_r$			0.6		1		1		1	
Turn-Off Time	$t_{d(off)}$			2							
	$t_f$			6							

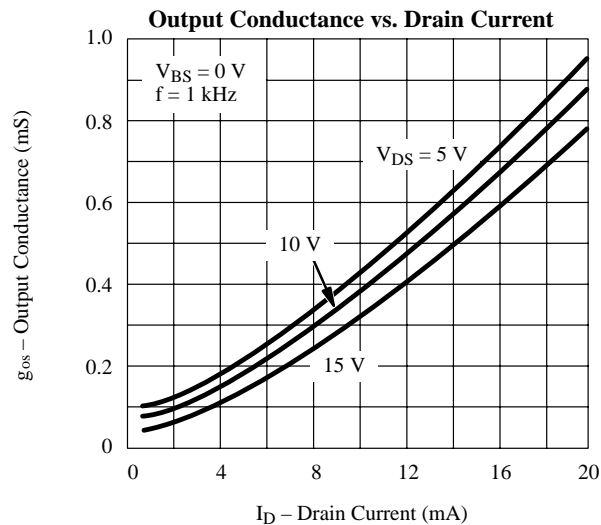
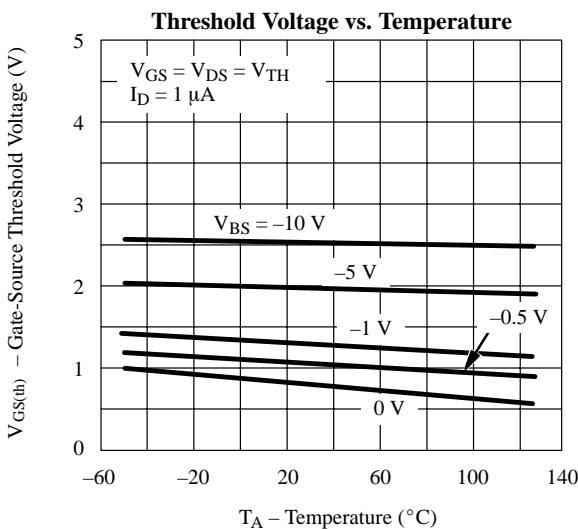
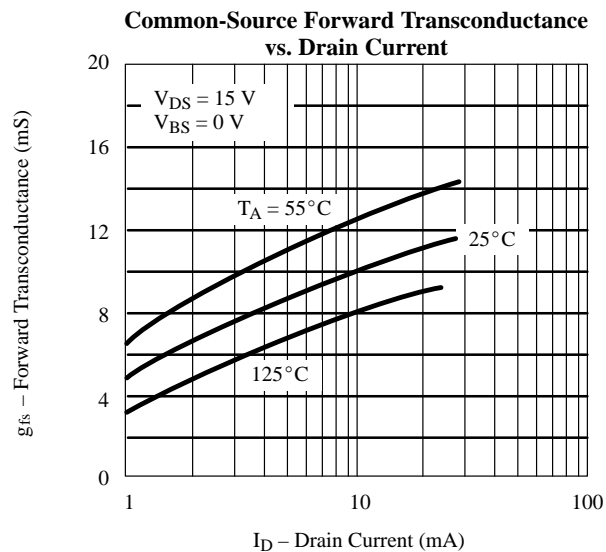
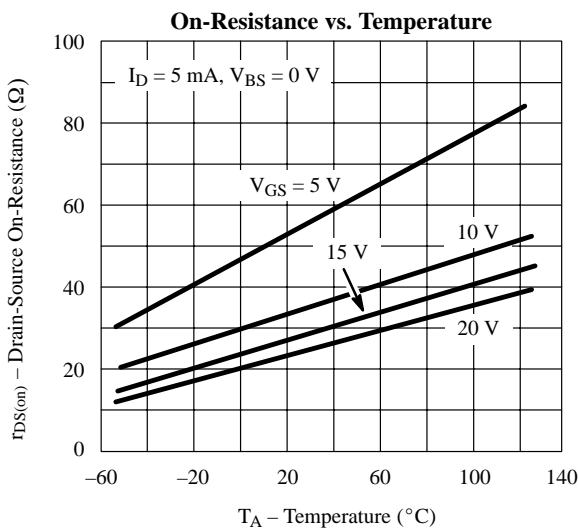
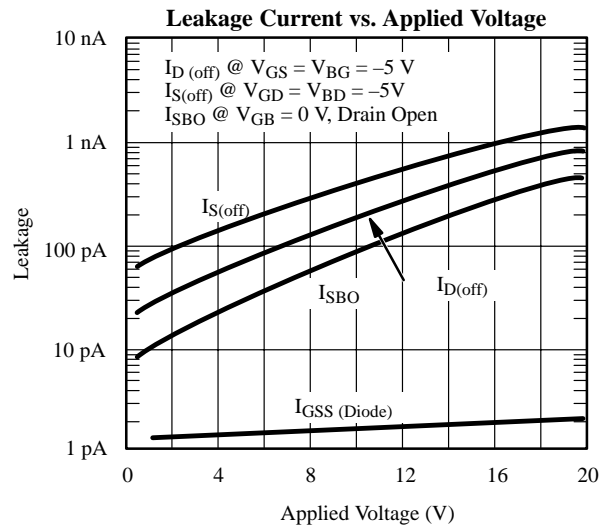
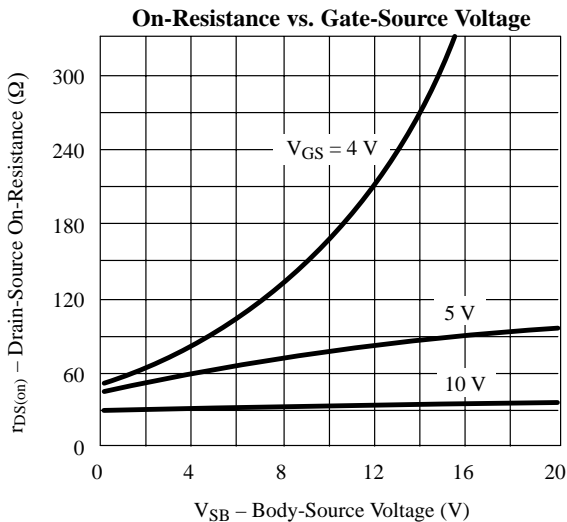
Notes:

- $T_A = 25^\circ\text{C}$  unless otherwise noted.
- B is the body (substrate), and (BR) is breakdown.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

DMCBA

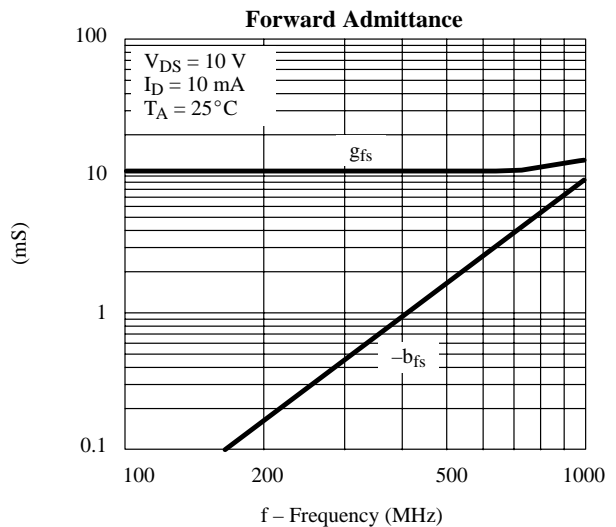
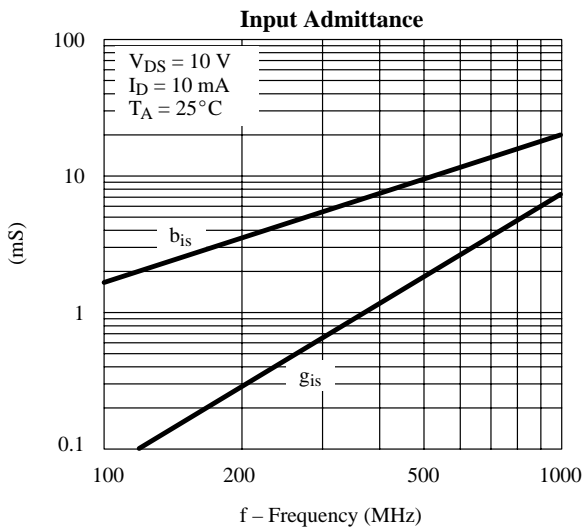
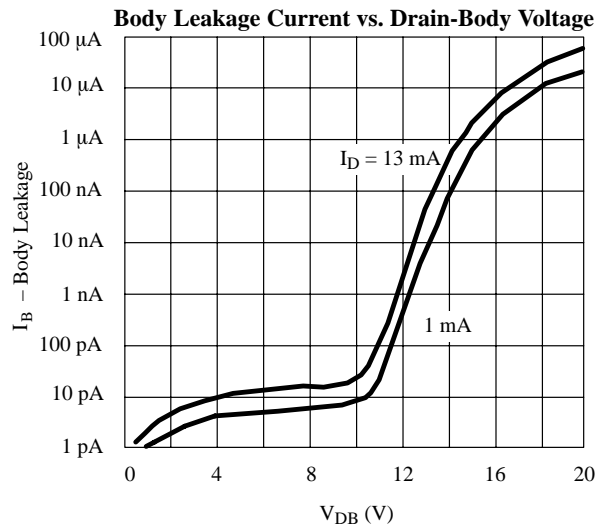
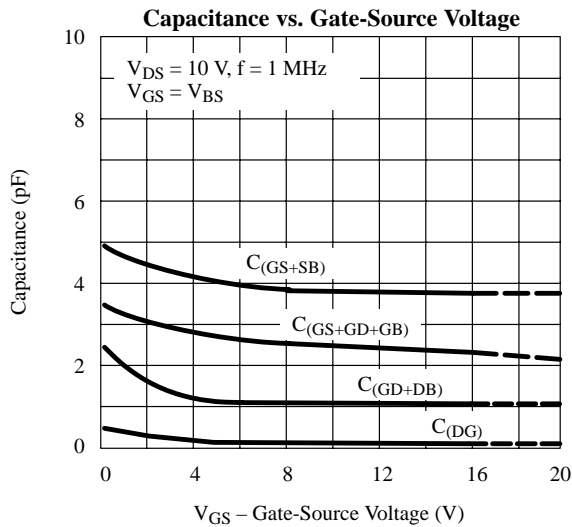
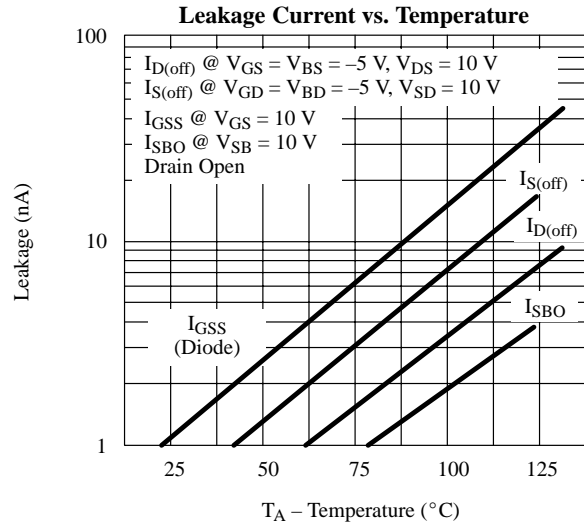
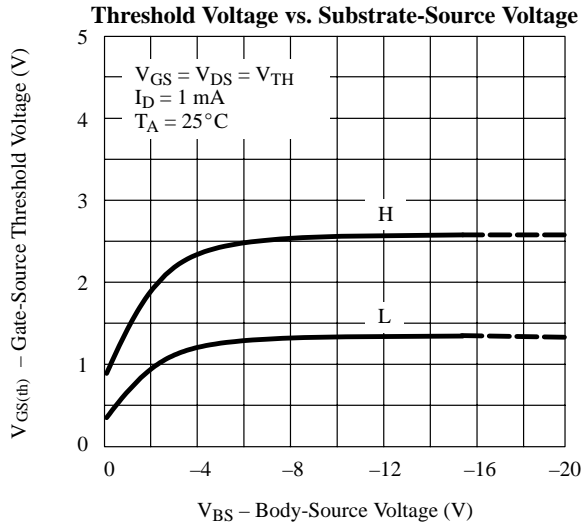
# SD211DE/SST211 Series

## Typical Characteristics



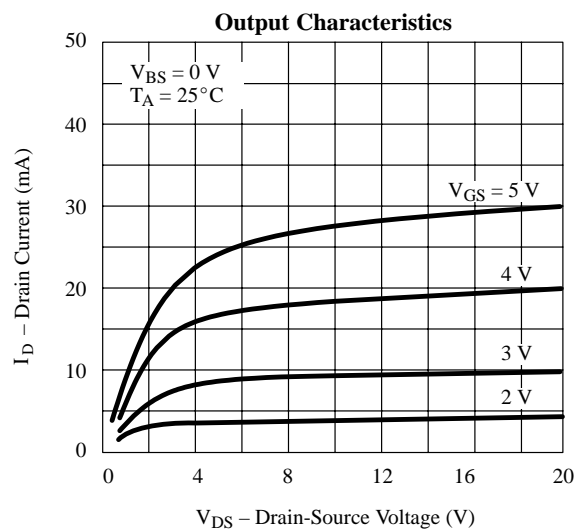
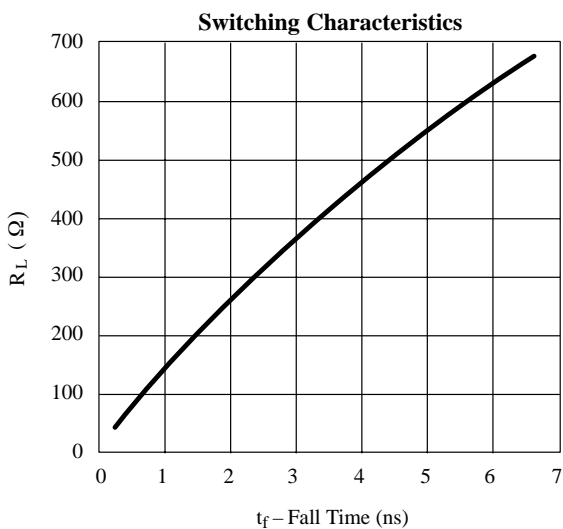
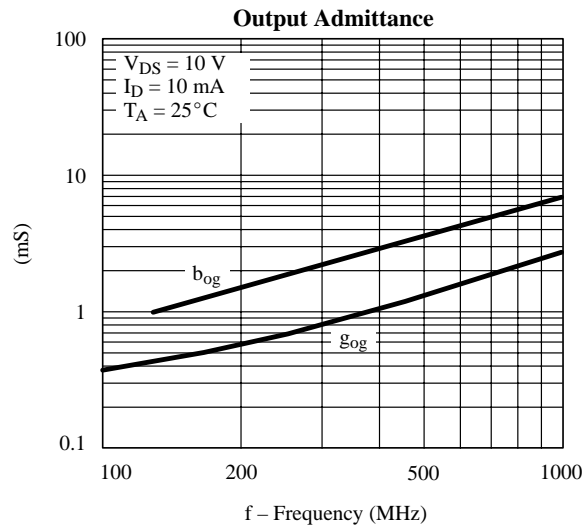
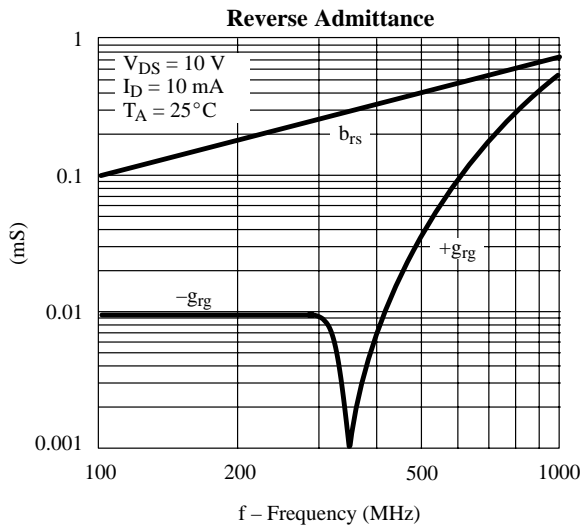
# SD211DE/SST211 Series

## Typical Characteristics (Cont'd)



# SD211DE/SST211 Series

## Typical Characteristics



## Switching Time Test Circuit

